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4-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

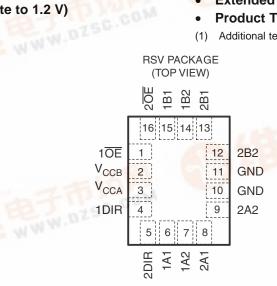
FEATURES

- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.2-V to 3.6-V Power-Supply Range
- I/Os Are 4.6-V Tolerant
- Ioff Supports Partial Power-Down-Mode Operation
- **Bus Hold on Data Inputs Eliminates the Need** for External Pullup/Pulldown Resistors
- **Max Data Rates**
 - 380 Mbps (1.8-V to 3.3-V Translation)
 - 200 Mbps (<1.8-V to 3.3-V Translation)
 - 200 Mbps (Translate to 2.5 V or 1.8 V)
 - 150 Mbps (Translate to 1.5 V)
 - 100 Mbps (Translate to 1.2 V)

- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- **ESD Protection Exceeds JESD 22**
 - 8000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

SUPPORTS DEFENSE, AEROSPACE, AND MEDICAL APPLICATIONS

- **Controlled Baseline**
- One Assembly/Test Site
- One Fabrication Site
- Available in Military (-55°C/125°C) Temperature Range⁽¹⁾
- **Extended Product Life Cycle**
- **Extended Product-Change Notification**
- **Product Traceability**
- Additional temperature ranges are available contact factory



DESCRIPTION/ORDERING INFORMATION

This 4-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. The SN74AVCH4T245 is optimized to operate with V_{CCA}/V_{CCB} set at 1.4 $\acute{\text{V}}$ to 3.6 $\acute{\text{V}}$. It is operational with $V_{\text{CCA}}/V_{\text{CCB}}$ as low as 1.2 $\acute{\text{V}}$. This allows for universal low-voltage bidirectional translation between any of the 1.2- $\acute{\text{V}}$, 1.5- $\acute{\text{V}}$, 1.8- $\acute{\text{V}}$, 2.5- $\acute{\text{V}}$, and 3.3- $\acute{\text{V}}$ voltage nodes.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

The SN74AVCH4T245 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input and the output-enable (\overline{OE}) input activate either the B-port outputs or the A-port outputs or place both output ports into the high-impedance mode. The device transmits data from the A bus to the B bus when the B-port outputs are activated, and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports is always active and must have a logic HIGH or LOW level applied to prevent excess I_{CC} and I_{CCZ} .

The SN74AVCH4T245 is designed so that the control pins (1DIR, 2DIR, 1OE, and 2OE) are supplied by V_{CCA}.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, then both ports are in the high-impedance state. The bus-hold circuitry on the powered-up side always stays active.

Active bus-hold circuitry holds unused or undriven inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION(1)

T _A	PACKA	GE ⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-55°C to 125°C	QFN - RSV	Tape and reel	CAVCH4T245MRSVREP	SODM	

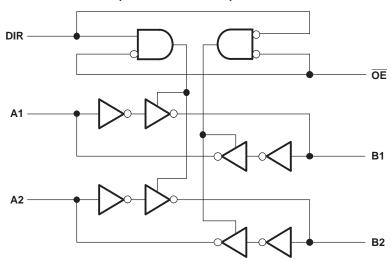
- (1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.
- (2) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI website at www.ti.com.

FUNCTION TABLE⁽¹⁾ (EACH 2-BIT SECTION)

CONTRO	L INPUTS	OUTPUT (CIRCUITS	OPERATION
ŌĒ	DIR	A PORT	B PORT	OPERATION
L	L	Enabled	Hi-Z	B data to A bus
L	Н	Hi-Z	Enabled	A data to B bus
Н	Χ	Hi-Z	Hi-Z	Isolation

(1) Input circuits of the data I/Os are always active.

LOGIC DIAGRAM (POSITIVE LOGIC) FOR 1/2 OF AVCH4T245



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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CCA}	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
V_{I}	Input voltage range ⁽²⁾	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output	A port	-0.5	4.6	V
Vo	in the high-impedance or power-off state (2)	B port	-0.5	4.6	V
.,	Valtage range applied to any output in the high or law state (2)(3)	A port	-0.5	V _{CCA} + 0.5	V
Vo	Voltage range applied to any output in the high or low state (2)(3)	B port	-0.5	V _{CCB} + 0.5	V
I _{IK}	Input clamp current	V _I < 0		- 50	mA
I _{OK}	Output clamp current	V _O < 0		- 50	mA
Io	Continuous output current	·		±50	mA
	Continuous current through V _{CCA} , V _{CCB} , or GND			±100	mA
θ_{JA}	Package thermal impedance			184	°C/W
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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⁽²⁾ The input voltage and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

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Recommended Operating Conditions (1)(2)(3)(4)(5)

			V _{CCI}	V _{cco}	MIN	MAX	UNIT
V _{CCA}	Supply voltage				1.2	3.6	V
V _{CCB}	Supply voltage				1.2	3.6	V
			1.2 V to 1.95 V		V _{CCI} × 0.65		
V_{IH}	High-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V		1.6		V
	input voltage		2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			V _{CCI} × 0.35	
V_{IL}	Low-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V			0.7	V
	input voltage		2.7 V to 3.6 V			0.8	
			1.2 V to 1.95 V		V _{CCA} × 0.65		
V_{IH}	High-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V		1.6		V
	input voltage	(referenced to VCCA)	2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			V _{CCA} × 0.35	
V_{IL}	Low-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V			0.7	V
	input voltage	(referenced to ACCV)	2.7 V to 3.6 V			0.8	
VI	Input voltage				0	3.6	V
\/	Outrot calta aa	Active state			0	V _{cco}	1/
V_O	Output voltage	3-state			0	3.6	V
				1.2 V		-3	
				1.4 V to 1.6 V		-6	
I_{OH}	High-level output curre	ent		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
I_{OL}	Low-level output curre	ent		1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
Δt/Δν	Input transition rise or	fall rate				5	ns/V
T _A	Operating free-air tem	perature			-55	125	°C

V_{CCI} is the V_{CC} associated with the input port.
V_{CCO} is the V_{CC} associated with the output port.
All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
For V_{CCI} values not specified in the data sheet, V_{IH} min = V_{CCI} × 0.7 V, V_{IL} max = V_{CCI} × 0.3 V.
For V_{CCA} values not specified in the data sheet, V_{IH} min = V_{CCA} × 0.7 V, V_{IL} max = V_{CCA} × 0.3 V.

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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST COND	ITIONS	V	V	Т	_A = 25°C		–55°C to 12	5°C	LINUT
PARAMETER	TEST COND	IIIONS	V _{CCA}	V _{CCB}	MIN	TYP	MAX	MIN	MAX	UNIT
	$I_{OH} = -100 \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V				V _{CCO} - 0.2		
	$I_{OH} = -3 \text{ mA}$		1.2 V	1.2 V		0.95				
V	$I_{OH} = -6 \text{ mA}$	\ \ \\	1.4 V	1.4 V				1.05		V
V _{OH}	$I_{OH} = -8 \text{ mA}$	$V_I = V_{IH}$	1.65 V	1.65 V				1.2		V
	$I_{OH} = -9 \text{ mA}$		2.3 V	2.3 V				1.75		
	$I_{OH} = -12 \text{ mA}$		3 V	3 V				2.3		
	$I_{OL} = 100 \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	
	$I_{OL} = 3 \text{ mA}$		1.2 V	1.2 V		0.15				
V	I _{OL} = 6 mA	\ \ \\	1.4 V	1.4 V					0.35	V
V_{OL}	I _{OL} = 8 mA	$V_I = V_{IL}$	1.65 V	1.65 V					0.45	V
	I _{OL} = 9 mA		2.3 V	2.3 V					0.55	
	I _{OL} = 12 mA		3 V	3 V					0.7	
I _I DIR input	V _I = V _{CCA} or GN	ID	1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μΑ
	V _I = 0.42 V		1.2 V	1.2 V		25				
I _{BHL} ⁽³⁾	V _I = 0.49 V V _I = 0.58 V		1.4 V	1.4 V				15		
			1.65 V	1.65 V				25		μΑ
	V _I = 0.7 V		2.3 V	2.3 V				45		
	V _I = 0.8 V		3.3 V	3.3 V				100		
	V _I = 0.78 V		1.2 V	1.2 V		-25				
	V _I = 0.91 V		1.4 V	1.4 V				-15		
I _{BHH} (4)	V _I = 1.07 V		1.65 V	1.65 V				-25		μΑ
	V _I = 1.6 V		2.3 V	2.3 V				-45		
	V _I = 2 V		3.3 V	3.3 V				-100		
			1.2 V	1.2 V		50				
			1.6 V	1.6 V				125		
I _{BHLO} ⁽⁵⁾	$V_I = 0$ to V_{CCI}		1.95 V	1.95 V				200		μΑ
			2.7 V	2.7 V				300		
			3.6 V	3.6 V				500		
			1.2 V	1.2 V		-50				
			1.6 V	1.6 V				-125		
I _{BHHO} ⁽⁶⁾	$V_I = 0$ to V_{CCI}	$V_I = 0$ to V_{CCI}	1.95 V	1.95 V				-200		μΑ
		2.7 V	2.7 V				-300			
		3.6 V	3.6 V				-500			

 V_{CCO} is the V_{CC} associated with the output port. V_{CCI} is the V_{CC} associated with the input port.

The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

The bus-hold circuit can source at least the minimum high sustaining current at VIH min. IBHH should be measured after raising VIN to V_{CC} and then lowering it to V_{IH} min.

An external driver must source at least I_{BHLO} to switch this node from low to high.

An external driver must sink at least I_{BHHO} to switch this node from high to low.

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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted) (continued)

DA	RAMETER	TEST CONDIT	IONE	V	V	T _A = 25°	С	-55°C to	125°C	LINIT
PA	KAWETER	TEST CONDIT	IONS	V _{CCA}	V _{CCB}	MIN TYP	MAX	MIN	MAX	UNIT
	A port	V_1 or $V_0 = 0$ to 3.6 \	,	0 V	0 V to 3.6 V	±0.1	±1		±13	^
l _{off}	B port	V ₁ 01 V ₀ = 0 to 3.6 V	,	0 V to 3.6 V	0 V	±0.1	±1		±13	μΑ
I _{OZ} ⁽³⁾	A or B port	$V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND	OE = V _{IH}	3.6 V	3.6 V	±0.5	±2.5		±5	4
loz (°)	B port	$V_O = V_{CCO}$ or	OE =	0 V	3.6 V				±14	μΑ
	A port	GND, $V_I = V_{CCI}$ or GND	don't care	3.6 V	0 V				±5	
				1.2 V to 3.6 V	1.2 V to 3.6 V				8	
I _{CCA}		$V_I = V_{CCI}$ or GND,	$I_O = 0$	0 V	3.6 V				-2	μΑ
				3.6 V	0 V				8	
				1.2 V to 3.6 V	1.2 V to 3.6 V				8	
I _{CCB}		$V_I = V_{CCI}$ or GND,	$I_O = 0$	0 V	3.6 V				8	μΑ
				3.6 V	0 V				-2	
I _{CCA} +	· I _{CCB}	$V_I = V_{CCI}$ or GND,	I _O = 0	1.2 V to 3.6 V	1.2 V to 3.6 V				16	μΑ
C _i	Control inputs	V _I = 3.3 V or GND		3.3 V	3.3 V	3.5			4.5	pF
C _{io}	A or B port	$V_O = 3.3 \text{ V or GND}$		3.3 V	3.3 V	6			7	pF

Switching Characteristics

over recommended operating free-air temperature range, $V_{\text{CCA}} = 1.2 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V ± 0.1 V	V _{CCB} = 1.8 V ± 0.15 V	V _{CCB} = 2.5 V ± 0.2 V	V _{CCB} = 3.3 V ± 0.3 V	UNIT														
	(INPUT)	(001F01)	TYP	TYP	TYP	TYP	TYP															
t _{PLH}	А	В	3.4	2.9	2.7	2.6	2.8	20														
t _{PHL}	A	Б	3.4	2.9	2.7	2.6	2.8	ns														
t _{PLH}	В	Α	3.6	3.1	2.8	2.6	2.6	20														
t _{PHL}	Ь	A	3.6	3.1	2.8	2.6	2.6	ns														
t _{PZH}	ŌĒ	^	5.6	4.7	4.3	3.9	3.7	ns														
t _{PZL}	OE	Α	5.6	4.7	4.3	3.9	3.7	115														
t _{PZH}	ŌĒ	В	5	4.3	3.9	3.6	3.6	20														
t _{PZL}	OE	В	В	В	В	В	В	В	В	В	В	В	В	В	5	4.3	3.9	3.6	3.6	ns		
t _{PHZ}	ŌĒ	OE	OF	OF.	Δ.	6.2	5.2	5.2	4.3	4.8	20											
t _{PLZ}	OE.	Α -	6.2	5.2	5.2	4.3	4.8	ns														
t _{PHZ}	ŌĒ	OE	D	5.9	5.1	5	4.7	5.5	20													
t _{PLZ}			OE	ŌĒ	ŌĒ	OE	OE	OE	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	В	5.9	5.1	5	4.7	5.5

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 V_{CCO} is the V_{CC} associated with the output port. V_{CCI} is the V_{CC} associated with the input port. For I/O ports, the parameter I_{OZ} includes the input leakage current.

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Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1		V _{CCB} = ± 0.1		V _{CCB} = ± 0.2		V _{CCB} = 3.3 V ± 0.3 V		UNIT	
	(INPUT)	(001F01)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX		
t _{PLH}	А	В	3.2	0.3	10.3	0.3	9.2	0.4	8.2	0.4	8.2	ns	
t _{PHL}	A	Ь	3.2	0.3	10.3	0.3	9.2	0.4	8.2	0.4	8.2	115	
t _{PLH}	В	Α	3.3	0.7	10.3	0.5	10	0.4	9.7	0.3	9.6	ns	
t _{PHL}	ь	A	3.3	0.7	10.3	0.5	10	0.4	9.7	0.3	13.6	115	
t _{PZH}	ŌĒ	^	4.9	1.4	13.6	1.1	13.5	0.7	13.4	0.4	13.4	20	
t _{PZL}	OE	OE A	4.9	1.4	13.6	1.1	13.5	0.7	13.4	0.4	13.4	ns	
t _{PZH}	ŌĒ	В	4.5	1.4	14.6	1.1	11.7	0.9	9.8	0.9	9.6	20	
t _{PZL}	OE	Ь	4.5	1.4	14.6	1.1	11.7	0.9	9.8	0.9	9.6	ns	
t _{PHZ}	=====================================	^	5.6	1.8	14.2	1.5	14.2	1.3	14.2	1.6	14.2	20	
t _{PLZ}	OE	ŌĒ A —	5.6	1.8	14.2	1.5	14.2	1.3	14.2	1.6	14.2	ns	
t _{PHZ}	ŌĒ	В	5.2	1.9	14.3	1.9	13.1	1.4	11.4	1.2	11.6	20	
t _{PLZ}	OE	ŌĒ	В	5.2	1.9	14.3	1.9	13.1	1.4	11.4	1.2	11.6	ns

Switching Characteristics

over recommended operating free-air temperature range, $V_{\text{CCA}} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1		V _{CCB} = ± 0.1	= 1.8 V 15 V	V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT														
	(INFOT)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX															
t _{PLH}	Α	В	2.9	0.1	10	0.1	8.9	0.1	7.9	0.3	7.9	no														
t _{PHL}	A	Б	2.9	0.1	10	0.1	8.9	0.1	7.9	0.3	7.9	ns														
t _{PLH}	В	Α	3	0.6	9.3	0.5	8.9	0.3	8.6	0.3	8.5	no														
t _{PHL}	ь	A	3	0.6	9.3	0.5	8.9	0.3	8.6	0.3	8.5	ns														
t _{PZH}	ŌĒ	Α	4.4	1	13.4	1	11.3	0.6	11.3	0.4	11.2															
t _{PZL}	OE	А	4.4	1	13.4	1	11.3	0.6	11.3	0.4	11.2	ns														
t _{PZH}	ŌĒ	В	4.1	1.2	14.4	1	12.4	0.8	9.3	0.8	8.6	no														
t _{PZL}	OE	Ь	4.1	1.2	14.4	1	12.4	0.8	9.3	0.8	8.6	ns														
t _{PHZ}	- OE	<u> </u>	0 -	Α	5.4	1.6	12.6	1.8	12.7	1.3	12.7	1.6	12.7	no												
t _{PLZ}		A	5.4	1.6	12.6	1.8	12.7	1.3	12.7	1.6	12.7	ns														
t _{PHZ}		ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	OE .	OE	ŌĒ B	5	1.7	13.9	1.6	12.7	1.2	10.9	1	10.9	20
t _{PLZ}														ם	5	1.7	13.9	1.6	12.7	1.2	10.9	1	10.9	ns		

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Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1		V _{CCB} = ± 0.1		V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT												
	(INPUI)	(OUTPUT)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX													
t _{PLH}	А	В	2.8	0.1	9.7	0.1	8.6	0.2	7.5	0.1	7.6	ns												
t _{PHL}	A	Ь	2.8	0.1	9.7	0.1	8.6	0.2	7.5	0.1	7.6	115												
t _{PLH}	В	Α	2.7	0.6	8.2	0.4	7.9	0.2	7.4	0.2	7.3	ns												
t _{PHL}	В	Ď		A	2.7	0.6	8.2	0.4	7.9	0.2	7.4	0.2	7.3	110										
t _{PZH}	ŌĒ	Α	4	0.7	10.5	0.7	9.2	0.6	8.8	0.4	8.8	ns												
t _{PZL}	OE	A	4	0.7	10.5	0.7	9.2	0.6	8.8	0.4	8.8	115												
t _{PZH}	ŌĒ	В	3.8	0.9	14.8	8.0	12	0.6	9.8	0.6	9	ns												
t _{PZL}	OE	Ь	3.8	0.9	14.8	0.8	12	0.6	9.8	0.6	9	115												
t _{PHZ}	ᅙ	Α	4.7	1	12.4	1	12.4	1	10.2	1	10.6	ns												
t _{PLZ}	ŌĒ	A	4.7	1	12.4	1	12.4	1	10.2	1	10.6	115												
t _{PHZ}	ŌĒ	В	4.5	1.5	13.4	1.3	12.2	1.1	10.2	0.9	9.2	20												
t _{PLZ}	OĒ	ŌĒ	OE	OE	OE	OE	OE	OE	OE	OE	OE	OE	ŌĒ	ם	4.5	1.5	12.8	1.3	12.2	1.1	10.2	0.9	9.2	ns

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V ± 0.3 V (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1		V _{CCB} = ± 0.1		V _{CCB} = ± 0.2		V _{CCB} = 3.3 V ± 0.3 V		UNIT															
	(INPOT)	(001701)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX																
t _{PLH}	А	В	2.9	0.1	9.6	0.1	8.5	0.1	7.3	0.1	6.9																
t _{PHL}	A	В	2.9	0.1	9.6	0.1	8.5	0.1	7.3	0.1	6.9	ns															
t _{PLH}	В	Α	2.6	0.6	8.2	0.4	7.4	0.2	7	0.1	6.8	20															
t _{PHL}	Ь	A	2.6	0.6	8.2	0.4	7.4	0.2	7	0.1	6.8	ns															
t _{PZH}	ŌĒ	^	3.8	0.6	12.7	0.6	9.2	0.6	7.8	0.4	7.8																
t _{PZL}	OE	Α	3.8	0.6	12.7	0.6	9.2	0.6	7.8	0.4	7.8	ns															
t _{PZH}	ŌĒ	В	3.7	0.8	14.7	0.6	11.8	0.5	9.7	0.5	8.8	20															
t _{PZL}	OE	В	3.7	0.8	14.7	0.6	11.8	0.5	9.7	0.5	8.8	ns															
t _{PHZ}	OE OE	0 -	0 -	0 -	0 -	0 -		<u> </u>	OE .	OE .	ŌĒ	<u> </u>	0 -	^	4.8	0.7	13.3	0.7	12.3	0.7	9.6	0.7	10.6	20			
t _{PLZ}		ŌĒ A	4.8	0.7	13.3	0.7	12.3	0.7	9.6	0.7	10.6	ns															
t _{PHZ}		ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	ŌĒ	0 -	0 -	0 -	0 -	OF.	ŌĒ B	5.3	1.4	13.3	1.2	12.1	1	10.4	0.8	10.2	20
t _{PLZ}												B	5.3	1.4	13.3	1.2	12.1	1	10.4	0.8	10.2	ns					

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SCES771-DECEMBER 2008

Operating Characteristics

 $T_A = 25^{\circ}C$

F	PARAME	TER	TEST CONDITIONS	V _{CCA} = V _{CCB} = 1.2 V	V _{CCA} = V _{CCB} = 1.5 V	V _{CCA} = V _{CCB} = 1.8 V	V _{CCA} = V _{CCB} = 2.5 V	V _{CCA} = V _{CCB} = 3.3 V	UNIT
	A += D	Outputs enabled		1	1	1	1.5	2	
C _{pdA} ⁽¹⁾	A to B	Outputs disabled	$C_{L} = 0,$	1	1	1	1	1	n.E
CpdA	R to A	Outputs enabled	f = 10 MHz, $t_r = t_f = 1 \text{ ns}$	12	12.5	13	14	15	pF
	B to A	Outputs disabled		1	1	1	1	1	
	A to B	Outputs enabled		12	12.5	13	14	15	
C _{pdB} ⁽¹⁾	AIOB	Outputs disabled	$C_L = 0$,	1	1	1	1	1	~F
□pdB` /	D to A	Outputs enabled	f = 10 MHz, $t_r = t_f = 1 \text{ ns}$	1	1	1	1	2	pF
B to A	Outputs disabled		1	1	1	1	1		

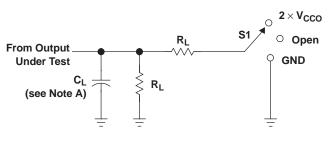
⁽¹⁾ Power dissipation capacitance per transceiver

 V_{CCA}

CCA/2



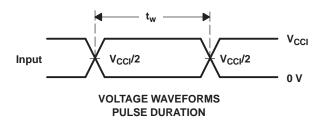
PARAMETER MEASUREMENT INFORMATION



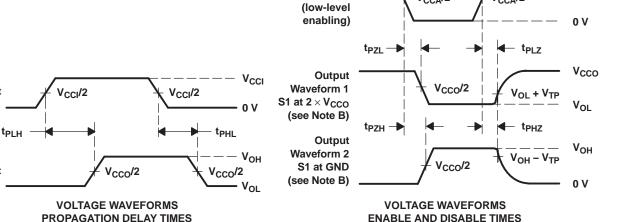
TEST	S 1
t _{pd}	Open 2 × V _{CCO}
t _{PHZ} /t _{PZH}	GND

LOAD CIRCUIT

V _{CCO}	CL	R _L	V _{TP}
1.2 V	15 pF	2 k Ω	0.1 V
1.5 V \pm 0.1 V	15 pF	2 k Ω	0.1 V
1.8 V ± 0.15 V	15 pF	2 k Ω	0.15 V
2.5 V \pm 0.2 V	15 pF	2 k Ω	0.15 V
3.3 V \pm 0.3 V	15 pF	2 k Ω	0.3 V



V_{CCA}/2



Output Control

NOTES: A. C_L includes probe and jig capacitance.

Input

Output

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $dv/dt \geq$ 1 V/ns, $dv/dt \geq$ 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

Figure 1. Load Circuit and Voltage Waveforms



PACKA

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Pea
CAVCH4T245MRSVREP	ACTIVE	UQFN	RSV	16	3000	TBD	Call TI	Call TI
V62/09618-01XE	ACTIVE	UQFN	RSV	16	3000	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retard in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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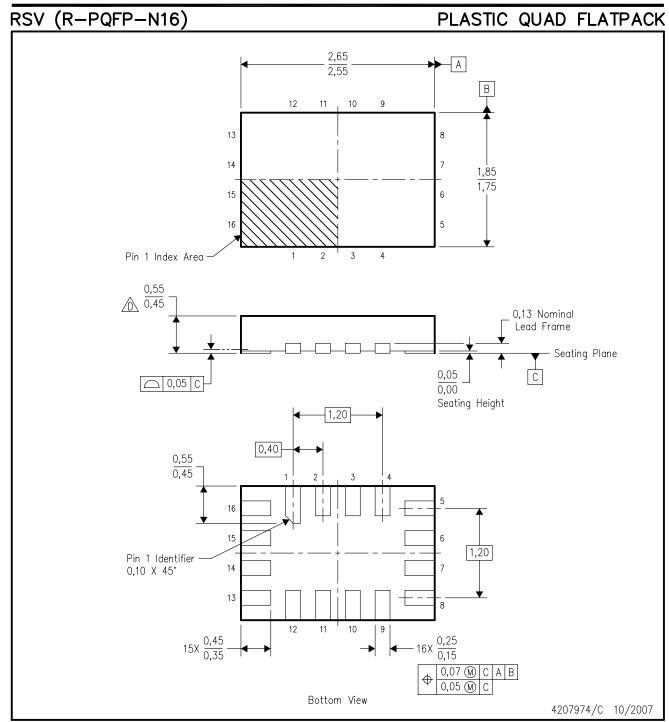
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NOTE: Qualified Version Definitions:



PACKA

Catalog - TI's standard catalog product

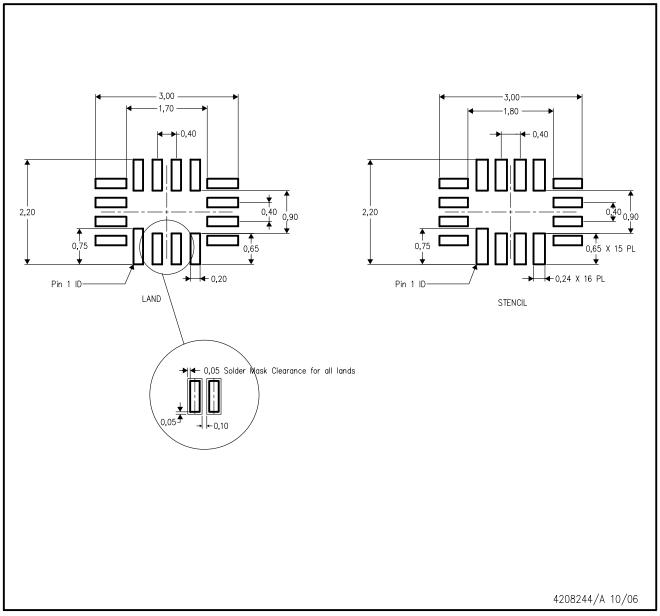


NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. QFN (Quad Flatpack No-Lead) package configuration.
- This package complies to JEDEC MO-288 variation UFHE, except minimum package thickness.



RSV (R-PQFP-N16)



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Customers should contact their board fabrication site for minimum solder mask web tolerances between signal pads.
- E. Maximum stencil thickness 0,127 mm (5 mils). All linear dimensions are in millimeters.
- F. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
- G. Side aperture dimensions over—print land for acceptable area ratio > 0.66. Customer may reduce side aperture dimensions if stencil manufacturing process allows for sufficient release at smaller opening.



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